



**Reverse Voltage: 150,200V
Forward Current: 20A**

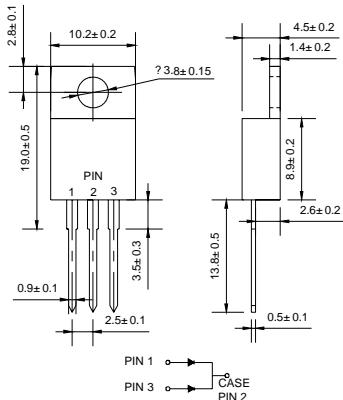
TO-220AB

Features

- ❖ Metal-Semiconductor junction with guard ring
- ❖ Epitaxial construction
- ❖ Low forward voltage drop, low switching losses
- ❖ High surge capacity
- ❖ For use in low voltage, high frequency inverters free wheeling, and polarity protection applications
- ❖ The plastic material carries U/L recognition 94V-0

Mechanical Data

- ❖ **Case:** JEDEC TO-220AB, molded plastic body
- ❖ **Polarity:** As marked
- ❖ **Mounting Position:** Any
- ❖ **Weight:** 0.071 ounce, 2.006 grams



Dimensions in millimeters

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

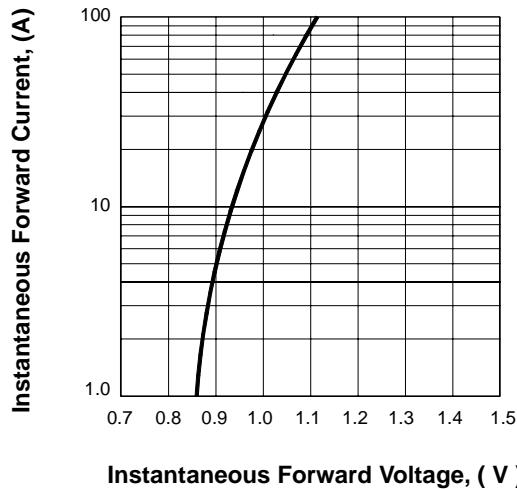
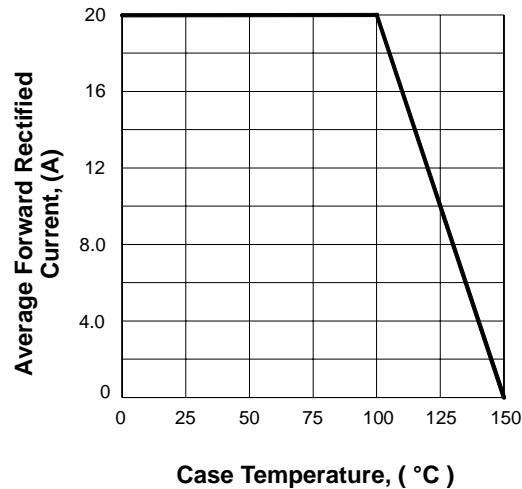
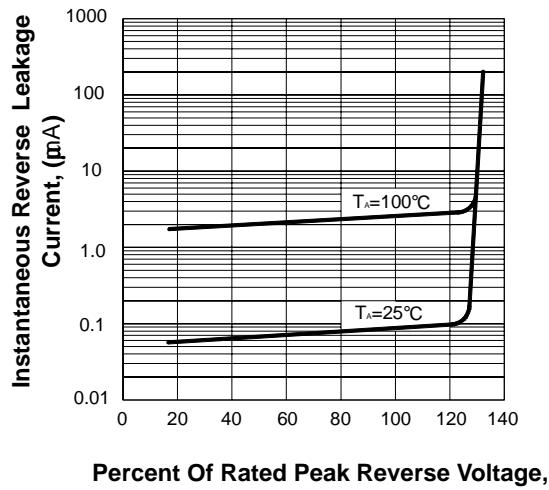
Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbol	MBR20150CT	MBR20200CT	UNITS
Maximum recurrent peak reverse voltage	V _{RRM}	150	200	V
Maximum RMS voltage	V _{RWS}	135	140	V
Maximum DC blocking voltage	V _{DC}	150	200	V
Maximum average forward total device rectified current @T _C =100°C	I _(AV)	20		A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}		150	A
Maximum instantaneous forward voltage @10A	V _F		0.95	V
Maximum reverse current @T _A =25°C at rated DC blocking voltage @T _A =100°C	I _R	0.2 50		mA
Maximum thermal resistance (Note1)	R _{θJC}	1.5		°C/W
Operating junction temperature range	T _J	-55 --- +150		°C
Storage temperature range	T _{STG}	-55 --- +150		°C

NOTES: 1. Thermal resistance from junction to case.

Ratings AND Characteristic Curves

FIG.1 TYPICAL FORWARD CHARACTERISTICS

FIG.2 FORWARD DERATING CURVE

FIG.3 TYPICAL REVERSE CHARACTERISTICS

FIG.4 PEAK FORWARD SURGE CURRENT
